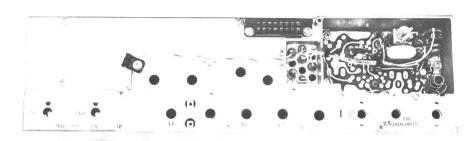


ASTR Progress Line

25-50 MHz DUAL FRONT END MODELS 19D402497-G7 THRU G9 (WITH SEARCH-LOCK MONITOR)



SPECIFICATIONS

FREQUENCY RANGE 19D402497-G7 19D402497-G8 19D402497-G9

SENSITIVITY

12-dB SINAD 20-dB quieting

INTERMODULATION (EIA)

INPUT POWER

FREQUENCY STABILITY

TRANSISTORS

INPUT POWER

TRANSISTORS

TEMPERATURE RANGE

DIMENSIONS (HxWxD)

25-33 MHz

33-42 MHz

42-50 MHz

0.25 microvolt 0.35 microvolt

-60 dB

.010 Amps at 10 volts

 $\pm .0005\%$ (-30°C to +60°C)

2-1/4" x 11-3/4" x 4-3/8"

SEARCH-LOCK MONITOR 19A121599-G1

SEARCH RATE (Receiver squelched)

Samples each channel approximately

ten times per second.

.005 Amps at 10 volts

3

 -30° C to $+60^{\circ}$ C (-22° F to $+140^{\circ}$ F)

2" x 2-3/4" x 3/4"

DIMENSIONS (HxWxD)

^{*}These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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DESCRIPTION

DUAL FRONT END

General Electric Dual Front End Models 19D402497-G7 thru -G9 are designed for operation in the 25—50 megahertz range. The Dual Front End (DFE) is used in crossband applications with 132-174 megahertz MASTR Progress Line receivers.

The DFE is of single-unit construction, completely housed in an aluminum casting for maximum shielding and rigidity. The unit consists of an RF amplifier, mixer, oscillator and two multiplier stages. The output feeds directly into the receiver crystal filter as shown in Figure 1. The chassis is mounted in a housing on the rear of the mobile frame and adding approximately three inches to the overall length of the mobile unit.

SEARCH-LOCK MONITOR (SLM)

Mobile combinations with Dual Front End are also equipped with Search-Lock Monitor to provide two-frequency monitoring. A three-position Search-Lock Monitor Switch (S705) is mounted on the Mobile Control The switch has F1, F1-F2 and F2 posi-When the switch is in the F1-F2 tions. position, no voltage is fed from S705 to either receiver crystal-switching diode or Dual Front End switching diodes and the Search-Lock Monitor operates. The Search-Lock Monitor then provides two-channel monitoring by alternately switching +10volts between the receiver crystal-switching diode and Dual Front End switching diodes at a rate of approximately ten times per second. When a signal is received on either channel, the SLM "locks" on that frequency for the duration of the signal (see Figure 2). Turning the switch to the F1 or F2 position applies +10 volts to the selected crystal-switching diode and overrides the SLM. Switching to the F1 or F2 position also connects the crystal-switching diode of the transmitter oscillator to ground, so that the receiver or Dual Front End will operate on the frequency determined by the selected transmitter and receiver/Dual Front End oscillator. With the switch in the F1-F2 position, the transmitter will operate on the F1 frequency only.

In combinations equipped with Channel Guard, the receiver Channel Guard operates only in the Fl position. The transmitter Channel Guard operates in the Fl and Fl-F2 position.

The Search-Lock Monitor board is mounted on the rear of the mobile system frame between the Dual Front End and the receiver.

DUAL ANTENNA SYSTEM (Figure 3)

Two antennas are required for cross-band operation. One antenna connects through antenna jack J902 on the front of the mobile unit to jack J1 on the DFE. The second antenna connects through J901 to the common terminal of antenna relay K901. The normally closed relay contact is connected to receiver antenna jack J441, and the normally open contact is connected to the transmitter.

CIRCUIT ANALYSIS

DUAL FRONT END

The MASTR Progress Line Dual Front End is completely transistorized using four

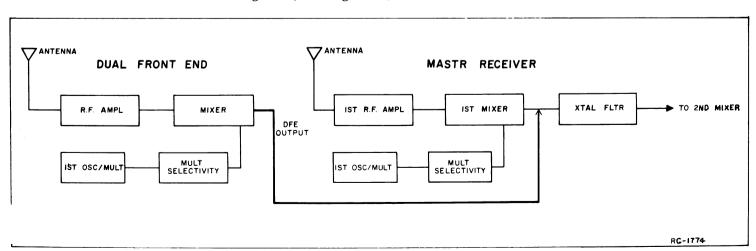


Figure 1 - Dual Front End Block Diagram

LBI-3991 DESCRIPTION

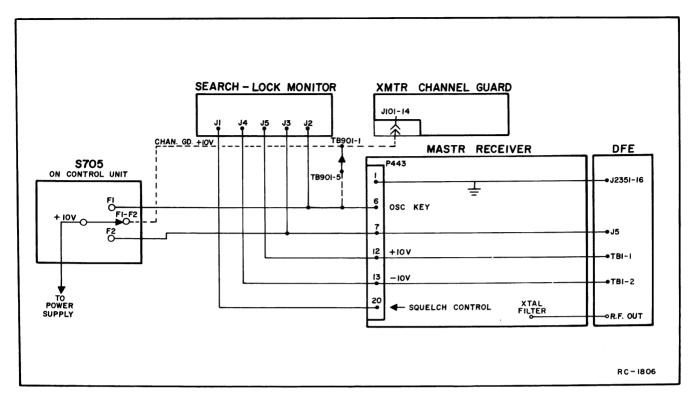


Figure 2 - Search-Lock Monitor Switching Diagram

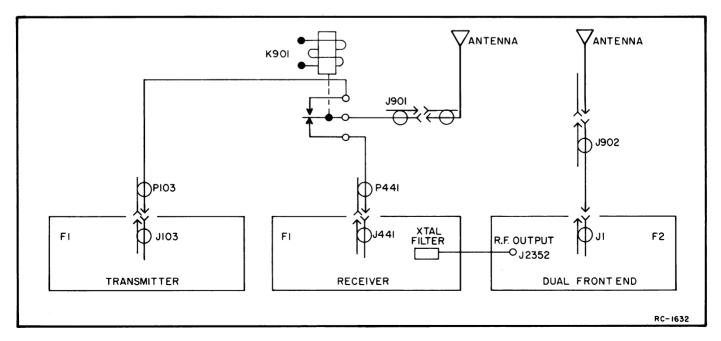


Figure 3 - Dual Antenna Block Diagram

silicon transistors. A regulated 10 volts is used for all stages of the Dual Front End.

Centralized metering jack J2351 is provided for use with the General Electric Test Set EX-3-A for ease of alignment and servicing. The Test Set meters the oscillator, multipliers, and the regulated 10 volts.

RF Amplifier (A2351)

RF Amplifier (A2351) consists of two high-Q helical resonators and an RF amplifier stage (Q1). The RF signal from the antenna is coupled by RF cable W2351 to a tap on L2351/L2353/L2355. The tap is positioned to insure the proper impedance match to the antenna. RF energy is coupled through the two coils by an opening in the shield wall to the base of RF Amplifier Q1. The coils are tuned to the incoming frequency by air trimmer capacitors C341 and C342. The output of Q1 is coupled through three tuned circuits to the base of the 1st mixer.

1st Oscillator and Multiplier (A2353-A2354)

The receiver 1st oscillator operates in a Transistorized Colpitts oscillator circuit. The oscillator crystal operates in a fundamental mode at a frequency of approximately 10 to 15 megahertz. The crystal is cut to provide temperature compensation at the high end of the temperature range and is thermistor compensated at low temperatures. This provides ±.0005% frequency stability as soon as the receiver is energized—without having to wait for crystal ovens to warm up.

Regulated 10 volts is supplied to the crystal circuit to forward bias diode CR1. Forward biasing the diode reduces its impedance, so that the crystal frequency is applied to the base of oscillator transistor Q1. Feedback for the oscillator is developed across C21/C22. The oscillator output is fed through C24 to the base of the 1st multiplier (Q2).

The output of the 1st multiplier (doubler Q2) is transformer-coupled (T3/T4) to multiplier selectivity assembly A2355/A2356. The 1st multiplier tank is tuned to three times the crystal frequency. The 1st multiplier stage is metered at the centralized metering jack J2351-4.

Multiplier Selectivity (A2355/2356)

Following the 1st multiplier tank (T3/T4) are three additional tuned circuits (L1, L2 and L3). Capacitor C12/C16 couples the multiplier selectivity output to the base of the 1st mixer.

1st Mixer (A2357)

The RF signal from the RF amplifier and the low-side injection voltage (42-50 MHz) and the high-side injection voltage (25-42 MHz) from the multiplier selectivity are applied to the base of 1st Mixer A2357-Q2. The output is connected from J2352 to the crystal filter in the receiver.

Centralized metering jack J2351 is provided for maintenance and alignment of the 1st multiplier. The four leads from the receiver plug P443 supplies the regulated 10 volts for the Dual Front End circuit, crystal switching, system negative, and ground connections.

SEARCH-LOCK MONITOR

The SLM circuit consists of a pulse generator (Q1) and a bistable multivibrator circuit (Q2 and Q3). The pulse generator operates at a nominal frequency of twenty pulses per second.

When the receiver is squelched, 9 volts from the collector of the receiver DC amp (Q8) is fed through Jl and R2 on the SLM board to the base of pulse generator Q1. This voltage causes Q1 to operate, sending a series of pulses to the base of switching transistors Q2 and Q3. These pulses activate the switching circuit which alternately applies +10 volts to each receiver oscillator-switching diode at a rate of approximately ten times per second.

When a signal is received, the receiver squelch opens; and the voltage at the base of Q1 drops almost to zero. This disables the pulse generator and switching circuit, and the +10 volt input from J5 is applied through R11 and Q2 or Q3 to the receiver oscillator. For example, if the first call is received on F1, the +10 volts is applied to the F1 receiver oscillator through R11 and Q2, locking the receiver on F1. Subsequent signals at F2 will not be heard while the F1 signal is being received.

When the signal at Fl stops, the receiver squelches and 9 volts is fed to the base of pulse generator Ql. Then Q2 and Q3 begin to switch back and forth until another signal is received.

Back bias is prevented from reaching the collectors of Q2 and Q3 by CR1 and CR2. CR4 biases Q3 off while Q2 is conducting, thereby preventing Q3 from conducting while Q2 is operating. The pulse generator circuit consists of R1, R2, R3, R13, R14, R15, RT1, C1 and Q1.

MAINTENANCE

DISASSEMBLY

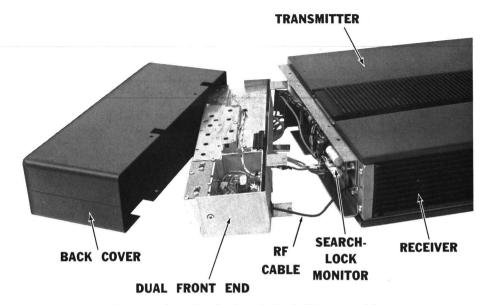


Figure 4 - Dual Front End Disassembly

Removing Dual Front End and/or Search-Lock Monitor:

Dual-Front End

- 1. Pull locking handle down and pull radio out of mounting frame.
- Remove the four screws holding back cover to system frame. Slide cover back and lift off (see Figure 4).
- 3. Remove four screws from angle brackets holding Dual Front End to the system frame.
- 4. Carefully swing Dual Front End chassis out for servicing.

Search-Lock Monitor

- 1. Follow Steps 1 through 4 above.
- Remove three screws holding circuit board to system frame (at rear of receiver).

TEST PROCEDURES

Dual Front End

SYMPTOM	CHECK
No Signal	1. Connections to P443.
	2. Cable from J2352 to receiver mixer board.
	3. Antenna terminal connections.
	4. Search-Lock Monitor switching circuit.
	5. Check 10-volt supply with GE Test Set on Position J, or pin 13 on DFE centralized metering jack J2351.
Low Sensitivity	1. DFE alignment.
	2. Cable and relay connections.
	3. RF Amplifier Q1 voltages.
	4. 1st Oscillator Q1 voltages.
Low Oscillator	1. Oscillator alignment.
Reading	2. Voltage readings at 1st Oscillator Q1.
	3. Crystal Y1.

MAINTENANCE LBI-3991

Search-Lock Monitor

- Turn the SLM switch to the F1-F2 (Search-Lock) positions and make sure that the receiver is squelched.
- 2. Connect positive probe of oscilloscope to junction of R1 and CR1 (for F1) or R22 and CR2 (for F2) on the oscillator board. Connect negative probe to J442-8 (negative). If SLM is operating, the signal should vary from zero to a positive voltage approximately ten times per second.
- 3. Next, unsquelch the receiver. The Search-Lock circuit will lock on one of the channels. Oscilloscope reading should be less than one volt on OFF channel (not conducting) and 6.6 volts on ON channel (conducting).
- 4. Switch to the Fl position. Reading at junction of Rl and CRl should be approximately 6.6 volts. Then switch to the F2 position. Reading at junction of R2 and CR2 should be approximately 6.6 volts.

DUAL FRONT END ALIGNMENT

EQUIPMENT REQUIRED

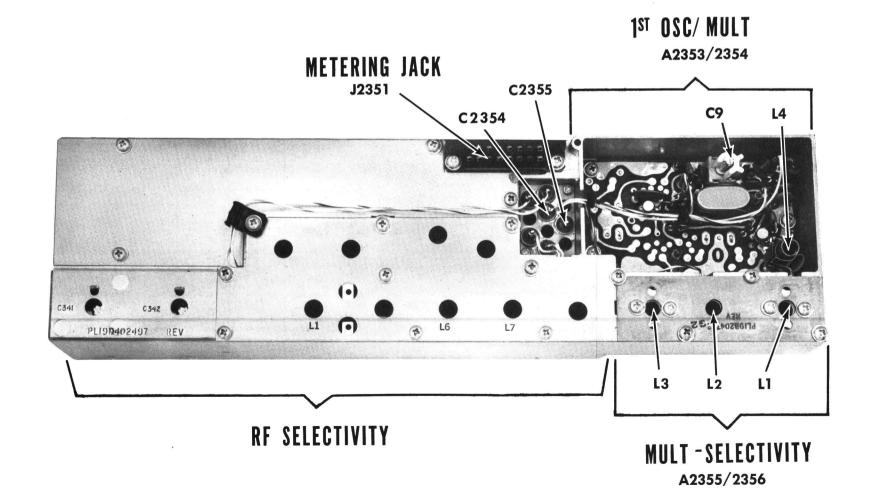
- 1. GE Test Set Model 4EX3AlO or a 20,000 ohm-per-volt multimeter.
- 2. 455 kHz and 25-50 MHz range Signal Generator. Connect a one-inch piece of insulated wire no larger than .065-inch diameter to generator output probe.

PRELIMINARY CHECKS AND ADJUSTMENTS

- 1. With test set in position J, check for regulated 10 volts. If using multimeter, measure between C2354 and C2355.
- 2. If using multimeter for alignment, connect positive lead to J2351-16 (ground).
- 3. Set crystal trimmer C9 (1st Osc/Mult) to mid-capacity. Then set the frequency selector switch to the F2 position.

Refer to Receiver MAINTENANCE MANUAL for Receiver Mixer and IF Alignment Procedure.

	METERING	POSITION			
STEP	GE Test Set or Meter Panel	Multimeter Minus at J2352	TUNING CONTROL	METER READING	PROCEDURE
			OSCILLATO	R - MULTIP	LIER
1	D	pin 4	L4 (1st OSCILLATOR) L1 (MULT-SELECTIVITY)	Max	Tune for peak reading.
2	D	pin 4	L2 (MULT-SELECTIVITY)	Min	Tune for minimum reading. Change voltage scale if necessary.
3	D	pin 4	L3 (MULT-SELECTIVITY)	Max	Tune for maximum reading.
			RF (CIRCUITS	
4	A	pin 10	Insert signal generator probe into L6 hole.	0	Adjust Signal Generator frequency for deflection on discriminator meter.
5	В	pin 2	L7, L6	Max	Peak L7. Insert generator probe in L1 hole and peak L6.
6			C341, C342 L1 (RF AMP)	Max	Connect generator to Ant input and peak C341, C342 and L1. Reduce signal to keep reading below 0.5 volt.
7			L1, (RF AMP) L6, L7	Max	Retune for maximum reading.
8	В	pin 2	L4 (1st OSCILLATOR) L1, L2, L3 (MULT- SELECTIVITY)	Max	Retune for maximum reading.
9			C341, C342		Tune for best sensitivity.



ALIGNMENT PROCEDURE

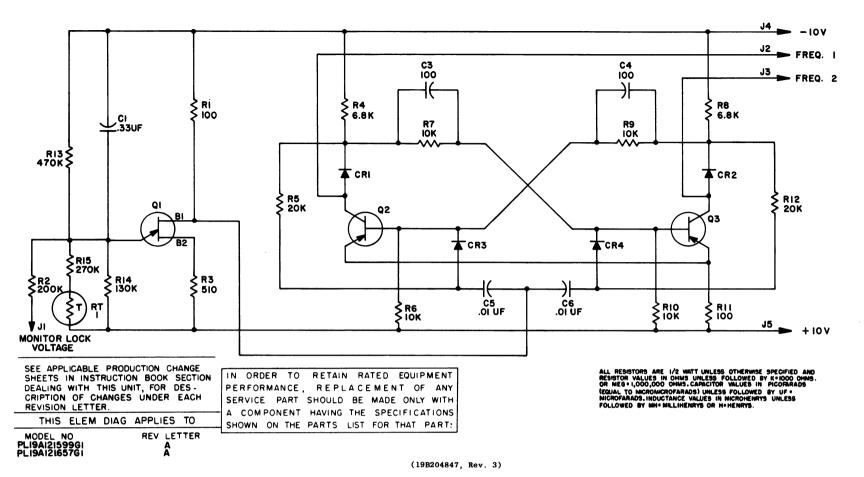
25—50 MHz DUAL FRONT END 19D402497-G7 thru -G9

LBI-3991

Issue 1



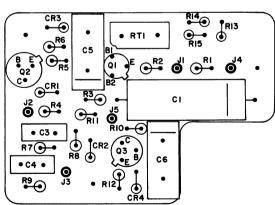
SCHEMATIC DIAGRAM



OUTLINE DIAGRAM

CONNECTIONS						
	FROM	ТО				
WIRE COLOR	SEARCH LOCK MONITOR BD.	MOBILE	STATION			
G-BK-R	JI	P443-20	P443-20 (RECEIVER)			
W-Y-BR	J2	P443-6	TB502-9 (EP-38-A)			
W-Y-R	J3	P443-7	TB502-8 (EP-38-A)			
W-0	٦Ħ	P443-13	TB501-12 (EP-38-A)			
W-R	J5	P443-12	TB501-7 (EP-38-A)			

SEARCH - LOCK MONITOR BOARD



(19C303818, Rev. 1)

SCHEMATIC & OUTLINE DIAGRAMS

SEARCH-LOCK MONITOR 19A121599-G1

Issue 1

PARTS LIST

LBI-3626B

SEARCH LOCK MONITOR KIT PL-19A121599-G1 (Mobile) PL-19A121647-G1 (Station)

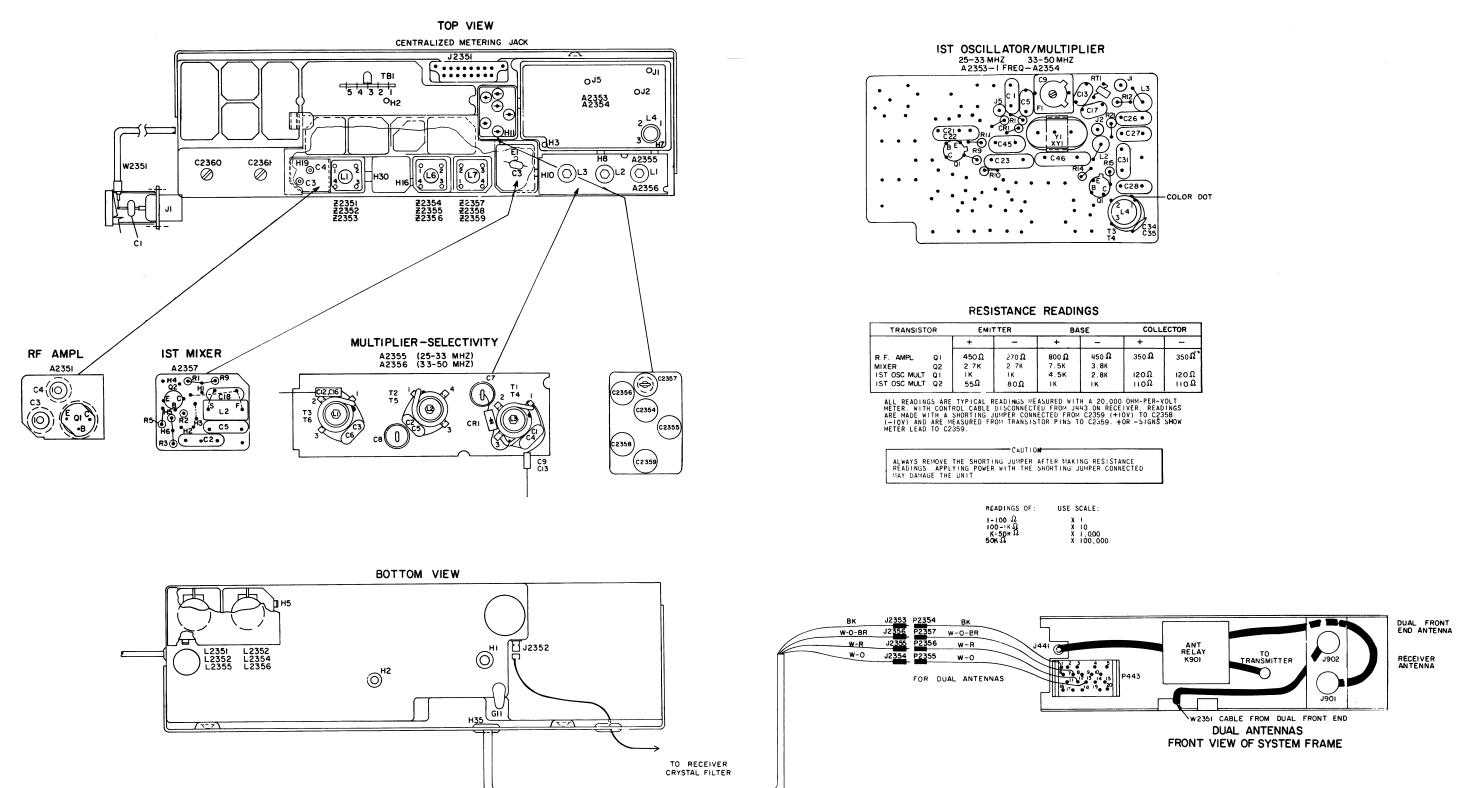
YMBOL	G-E PART NO.	DESCRIPTION
CR5	5494922-P1	Silicon: sim to Type 1N456. (used with 19A121599-Gl only). COMPONENT BOARD ASSEMBLY PL-19B204748-Gl
Cl	7491930-P11	Tubular, Mylare dielectric: axial leads, 0.33 µf ±20%, 100 VDCW; sim to G-E Type 61F.
C2*	7491930-P11	Tubular, Mylar® dielectric: axial leads, 0.33 at ±20%, 100 VDCW; sim to G-E Type 61F. Deleted by REV. A.
C3 and C4	5490008-P127	Silver mica, dipped phen: radial leads, 100 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
C5 and C6	19A115028-P107	Mylar® dielectric, dipped phen: radial leads, .01 µf ±20%, 200 VDCW.
		DIODES AND RECTIFIERS
CR1 thru CR4	5494922-P1	Silicon; sim to Type lN456.
		JACKS AND RECEPTACLES
J1 thru J5	4033513- P 4	Contact, electrical: sim to Bead Chain L93-3.
		TRANSISTORS
Q1	19Al15364-Pl	Silicon, unijunction; sim to Type 2N2646.
Q2 and Q3	19A115706-P1	Silicon, PNP; sim to Type 2N1024.
		RESISTORS
R1	3R152-P101K	Fixed composition: 100 ohms \pm 10%, 1/4 w.
R2	3R152-P204J	Fixed composition: 0.2 megohm $\pm 5\%$, $1/4$ w.
R3	3R152-P511K	Fixed composition: 510 ohms $\pm 10\%$, $1/4$ w.
R4	3R152-P682J	Fixed composition: 6800 ohms $\pm 5\%$, $1/4$ w.
R5	3R152-P203K	Fixed composition: 20,000 ohms $\pm 10\%$, $1/4$ w.
R6 and R7	3R152-P103J	Fixed composition: 10,000 ohms ±5%, 1/4 w.
R8	3R152-P682J	Fixed composition: 6800 ohms ±5%, 1/4 w.
R9 and R10	3R152-P103J	Fixed composition: 10,000 ohms ±5%, 1/4 w.
R11	3R152-P101J	Fixed composition: 100 ohms $\pm 5\%$, I/4 w.
R12	3R152-P203K	Fixed composition: 20,000 ohms ±10%, 1/4 w.
R13	3R152-P474J	Fixed composition: 0.474 megohm ±5%, 1/4 w. Added by REV. A.
R14	3R152-P134J	Fixed composition: 0.134 megohm $\pm 5\%$, $1/4$ w. Added by REV. A.
R15	3R152-P274J	Fixed composition: 0.274 megohm $\pm 5\%$, $1/4$ w. Added by REV. A.
RT1	5490828-P37	
	19A121648-G1	Station Support Assembly.
	19A121592-G1	Mobile support assembly.
	19A121603-G1	Cable Assembly, 24" long. (Used with PL-PL-19A121592-G1 only).
	19B204903-G1	Cable Assembly, 23" long (Used with PL-19A121647-G1 only).

^{*}COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

PRODUCTION CHANGES

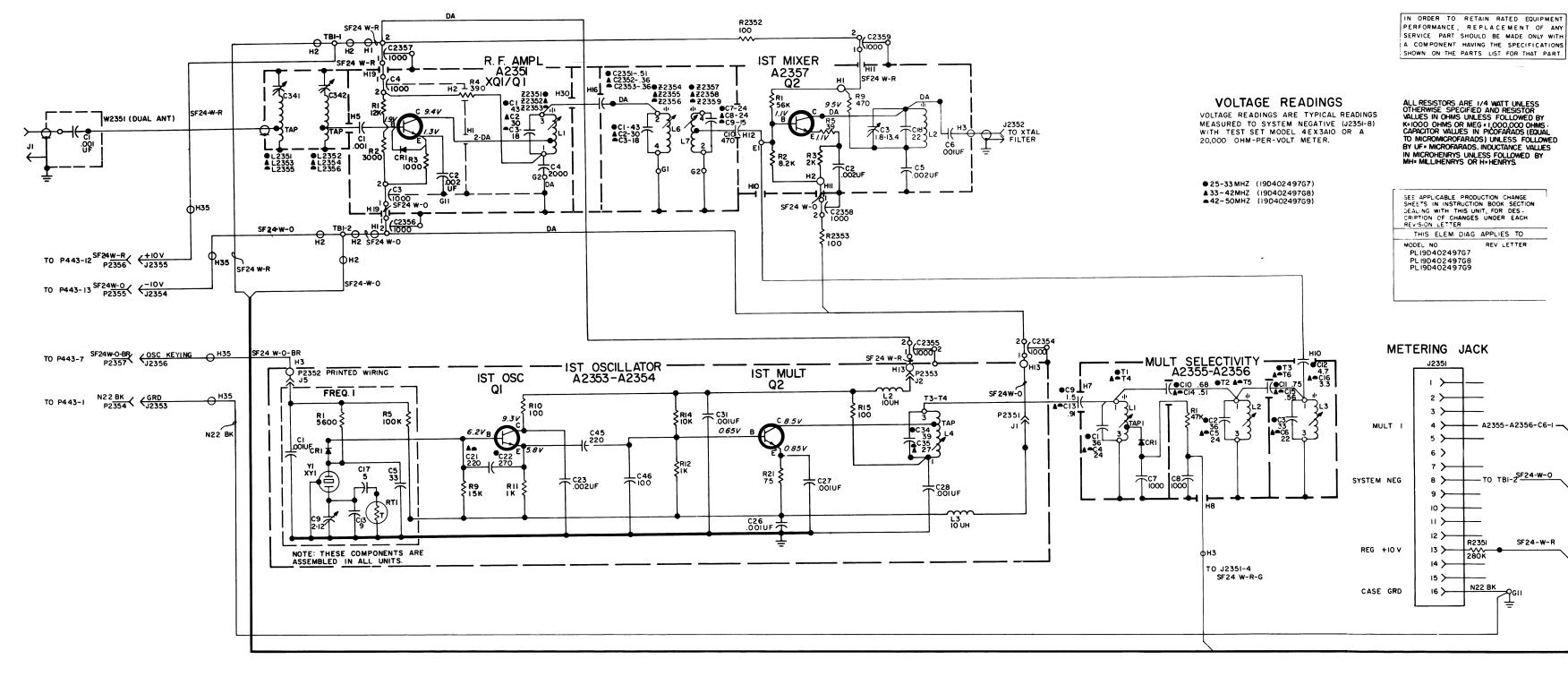
Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - To increase search rate.
Deleted C2 and added R13, R14, R15, and RT1.



(19R621268. Rev. 0)

OUTLINE DIAGRAM



(19R621239. Rev. 1)

SCHEMATIC & OUTLINE DIAGRAMS

DUAL FRONT END, 25—50 MHz 19D402497-G7 thru -G9 LBI-3991

PARTS LIST

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

						1 1	*				
		LBI-3992		7499070 PIG	INDUCTORS	C7 and C8	5493392-P107	Ceramic, stand-off: .001 μf +100% -0%, 500 VDCW; sim to Allen-Bradley Type SS5A.	C2354 thru C2359	5493392-P7	Ceramic, feed-thru: .001 µf +100% -0%, 500 sim to Allen-Bradley Type FA5C.
	25-	50 MHz DUAL FRONT END 19D402497-G7-9	L2 and L3	7488079-P16	Choke, RF: 10 μh ±10%, 0.6 ohm DC res; sim to Jeffers 4421-7.	C9	5491601-P123	Phenolic: 1.5 pf ±5%, 500 VDCW; sim to Quality Components Type MC.	C2339		JACKS AND RECEPTACLES
				!	TRANSISTORS	C10	5491601-P117	Phenolic: 0.68 pf ±5%, 500 VDCW; sim to Quality	J2351	19B205689-G2	Connector: 18 pin contacts.
SYMBOL	G-E PART NO.	DESCRIPTION	Q1 and	19A115330-P1	Silicon, NPN.	C11	5491601-P118	Components Type MC. Phenolic: 0.75 pf ±5%, 500 VDCW; sim to Quality Components Type MC.	J2352	19A115465-P1	Receptacle, coaxial: 500 v; sim to Micon Electronics Type 1104.
31/1/101	G-E TART TO:		Q2		RESISTORS	C12	5491601-P132	Phenolic: 4.7 pf ±5%, 500 VDCW; sim to Quality	J2353 thru	7147199-P1	Connector, brass: male contact; sim to Winchester Electronics 21803.
A2351		RF AMPLIFIER ASSEMBLY	R1	3R152-P562J	Composition: 5600 ohms ±5%, 1/4 w.	C13	5401601 P127	Components Type MC.	J2356		
		19B204772-G1	R9	3R152-P153J	Composition: 15,000 ohms $\pm 5\%$, 1/4 w.	! !	5491601-P137	Phenolic: 0.91 pf ±5%, 500 VDCW; sim to Quality Components Type MC.			INDUCTORS
		CAPACITORS	R10	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.	C14	5491601-P114	Phenolic: 0.51 pf ±5%, 500 VDCW; sim to Quality Components Type MC.	L2351 thru		COIL ASSEMBLY
C1	5494481-P12	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	R11 and R12	3R152-P102J	Composition: 1000 ohms ±5%, 1/4 w.	C15	5491601-P115	Phenolic: 0.56 pf $\pm 5\%$, 500 VDCW; sim to Quality Components Type MC.	L2356		L2351 19B204820-G5, L2352 19B204820-G6 L2353 19B204820-G1, L2354 19B204820-G2 L2355 19B204820-G3, L2356 19B204820-G4
C2	5494481-P14	Ceramic disc: .002 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	R14	3R152-P103J	Composition: 10,000 ohms ±5%, 1/4 w.	C16	5491601-P130	Phenolic: 3.3 pf ±5%, 500 VDCW; sim to Quality Components Type MC.			
C3	5493392-P7	Ceramic, feed-thru: .001 µf +100% -0%, 500 VDCW; sim to Allen-Bradley Type FA5C.	R15	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.				C2360	19B209159-P2	Variable, subminiature: approx 1.54-6.9 pf,
and C4		sim to Affen-Bradiey Type Thou.	R19	3R152-P360J	Composition: 36 ohms ±5%, 1/4 w.	CR1	4038056-P1	DIODES AND RECTIFIERS	and C2361		750 v peak; sim to EF Johnson 189-3-55.
		TRANSISTORS	R21	3R152-P750J	Composition: 75 ohms ±5%, 1/4 w.		100000-11				
Q1	19Al 15342-Pl	Silicon, NPN.					00150 04504		P2351	4029840-P2	Contact, electrical; sim to Amp 42827-2.
l		RESISTORS	RT1	19B209284-P5	Disc: 43 ohms res nominal at 25°C, color code green.	R1	3R152-P473K	Composition: 47,000 ohms ±10%, 1/4 w.	thru P2353		
R1	3R152-P123K	Composition: 12,000 ohms ±10%, 1/4 w.			TRANSFORMERS			TRANSFORMERS			RESISTORS
R2	3R152-P302K	Composition: 3000 ohms ±10%, 1/4 w.	тз		COIL ASSEMBLY	Tl	19B205325~G2	Coil. Includes Ll.	R2351	5495948-P444	Deposited carbon: 0.28 megohm $\pm 1\%$, $1/2$ w; s to Texas Instrument Type CD1/2MR.
R3	3R152-P102K	Composition: 1000 ohms ±10%, 1/4 w.	and T4		T3 19B205416-G1 T4 19B205416-G2	T2 T3	19B205325-G1 19B205325-G1	Coil. Includes L2. Coil. Includes L3.	R2352	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.
R4	3R152-P391K	Composition: 390 ohms ±10%, 1/4 w.			CAPACITORS	T4	19B205325-G2	Coil. Includes Ll.	and R2353		
					CAPACITORS	Т5	19B205325-Gl	Coil. Includes L2.			TERMINAL BOARDS
XQ1	5490277-P1	Transistor, mica-filled phen: 4 contacts rated at 1 amp at 400 VRMS; sim to Elco 3303.	C34	5496218-P253	Ceramic disc: 39 pf +5%, 500 VDCW, temp coef -80 PPM.	Т6	19B205325-G1	Coil. Includes L3.	TB1	7487424-P7	Miniature, phen: 4 terminals,
A2353		FIRST OSCILLATOR ASSEMBLY	C35	5496218-P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.	A2357		FIRST MIXER ASSEMBLY 19B204430-G2	W2351		
and A2354		A2353 19B204419-G13 (19D402497-G7) A2354 19B204419-G16 (19D402497-G8, 9)							W2351		CONN ECTOR ASSEMBLY 19B204930-G1
		A2334 19B204419-010 (19B402451-00, 5)	L4	19Al 2l 464-P2	Coil. Includes tuning slug 5491798-P5.	C2	5494481-P114				
l					SOCKETS	1		RMC Type JF Discap.	Cl	19B209141-P1	Ceramic disc: .001 µf ±10%, 500 VDCW.
C1	5494481-P112	Ceramic disc: .001 μ f $\pm 10\%$, 1000 VDCW; sim to RMC Type JF Discap.	XY1		Refer to Mechanical Parts (RC-1235).	СЗ	5491271-P106	Variable, sub-miniature: approx 2,1-12,7 pf, 750 v peak; sim to EF Johnson 189.			JACKS AND RECEPTACLES
C5	5496219-P751	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM.			CRYSTALS	C5	5494481-P114	Ceramic disc: 2000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	11	2R22-P3	Receptacle, panel, coaxial: mica-filled insert, UHF contact. Signal Corps SO-239 or
C9	5491271-P106	Variable, subminiature: approx 2.1-12.7 pf. 750 v peak; sim to EF Johnson 189-6-5.			When reordering give GE Part No. and specify exact freq needed.	C6	5494481-P12	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.			sim to Amphen1 83-1R.
C13	5496219-P40	Ceramic disc: 9 pf ±0.25 pf, 500 VDCW, temp coef 0 PPM.			25-42 MHz crystal freq = (OF +5.30 MHz) \div 3.	C18	5496218-P247	Ceramic disc: 22 pf ±5%, 500 VDCW, temp coef -80 PPM.			MI SCELLAN EOUS
C17	19C300685-P93	Ceramic_disc: 5 pf ±0.1 pf, 500 VDCW, temp			42-50 MHz crystal freq = (OF -5.30 MHz) \div 3.			COET -00 FFM.		19B209044-P19	Cable, RF: 1200 VRMS max, approx 40 inches.
C21	5496219-P771	Ceramic disc: 220 pf ±5%, 500 VDCW, temp coef	Yl	19B206576-P1	Quartz: freq range 10086,666 to 12766,666 KHz temp range -30°C to +85°C, (25-33 MHz),		101101000 50				TUNED CIRCUITS
621	0130213 1111	-750 PPM.	Y1	19B206576-P2	Quartz: freq range 12766,667 to 15766,666 KHz	L2	19A121082-G2	Toroidal coil.	Z2351 thru		COIL ASSEMBLY
C22	5496219-P773	Ceramic disc: 270 pf ±5%, 500 VDCW, temp coef -750 PPM.) _{Y1}	19B206576-P3	temp range -30°C to .85°C, (33-42 MHz). Quartz: freq range 12233,333 to 16233,333 KHz.			TRANSISTORS	Z2353		Z2351 19B204786-G1 Z2352 19B204786-G2 Z2353 19B204786-G3
C23	5494481-P114	Ceramic disc: .002 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.		15025015 15	temp range -30°C to 85°C. (42-50 MHz).	Q2	19A115245-P1	Silicon, NPN.			
C26	5494481-P112	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to	A2355 and		MULTIPLIER SELECTIVITY ASSEMBLY A2355 19B205326-61			RESISTORS	CI	5496218-P254	
thru C28		RMC Type JF Discap.	A2356		A2356 19B205326-G2	R1 R2	3R152-P563J 3R152-P822J	Composition: 56,000 ohms ±5%, 1/4 w. Composition: 8200 ohms ±5%, 1/4 w.	C2	5496218-P250	-80 PPM. Ceramic disc: 30 pf ±5%, 500 VDCW, temp coe
C31	5494481-P112	Ceramic disc: .001 μf ±10%, 1000 VDCW: sim to RMC Type JF Discap.			CAPACITORS	R3	3R152-P202J	Composition: 2000 ohms ±5%, 1/4 w.	1		-80 PPM.
C45	5490008-P35	Silver mica: 220 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	Cl and	5496218-P252	Ceramic disc: 36 pf ±5%, 500 VDCW, temp coef -80 PPM.	R5	3R152-P390J	Composition: 39 ohms ±5%, 1/4 w.	C3	5496218-P245	Ceramic disc: 18 pf ±5%, 500 VDCW, temp coe -80 PPM.
C46	5496219-P563	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef -330 PPM.	C2 C3	5496218-P251	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef	R9	3R152-P471K	Composition: 470 ohms $\pm 10\%$, $1/4$ w.	C4	5494481-P14	Ceramic disc: $.002~\mu f$ $\pm 10\%$, $1000~VDCW$; sim RMC Type JF Discap.
		-330 РРМ.			-80 PPM.						
	1000515	JACKS AND RECEPTACLES	C4 and C5	5496218-P248	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef -80 PPM.	C2351	5491601-P114	Tubular: 0.51 pf +5%, 500 VDCW; sim to Quality Components Type MC.	L1	19A121478-P2	Coil.
J1 thru J6	4033513-P4	Contact, electrical: sim to Bead Chain L93-3.	C6	5496218-P247	Ceramic disc: 22 pf ±5%, 500 VDCW, temp coef	C2352	5491601-P110	Tubular: 0.36 pf ±5%, 500 VDCW; sim to Quality		5491798-P1	Tuning slug. (Used in Z2351).
1 30					-80 PPM.	and C2353		Components Type MC.		5491798-P4	Tuning slug. (Used in Z2352).
										5491798-P5	Tuning slug. (Used in Z2353).
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DESCRIPTION

SYMBOL G-E PART NO

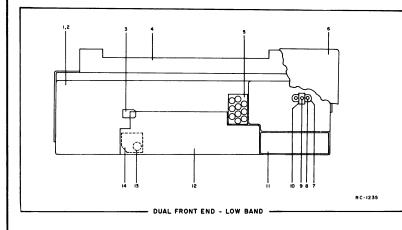
SYMBOL G-E PART NO

DESCRIPTION

SYMBOL G-E PART NO

0	DESCRIPTION	SYMBOL	G-E PART NO	DESCRIPTION
	Ceramic, feed-thru: .001 µf +100% -0%, 500 VDCW; sim to Allen-Bradley Type FA5C.	Z2354 thru Z2356		COIL ASSEMBLY Z2354 19B204767-G1 Z2355 19B204767-G2
	JACKS AND RECEPTACLES			Z2355 19B204767-G2 Z2356 19B204767-G3
	Connector: 18 pin contacts.			
	Receptacle, coaxial: 500 v; sim to Micon Electronics Type 1104.	C1	5496218-P254	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef
	Connector, brass: male contact; sim to	C2	5496218-P250	Ceramic disc: 30 pf ±5%, 500 VDCW, temp coef
	Winchester Electronics 21803.	СЗ	5496218-P245	-80 PPM. Ceramic disc: 18 pf ±5%, 500 VDCW, temp coef
			0430210-F243	-80 PPM.
	COIL ASSEMBLY			MI SCELLAN EOUS
	L2351 19B204820-G5, L2352 19B204820-G6 L2353 19B204820-G1, L2354 19B204820-G2		5491798-P1	Tuning slug. (Used in Z2354).
	L2355 19B204820-G3, L2356 19B204820-G4		5491798-P4 5491798-P5	Tuning slug. (Used in Z2355). Tuning slug. (Used in Z2356).
			0431135-25	
	Variable, subminiature: approx 1.54-6.9 pf, 750 v peak; sim to EF Johnson 189-3-55.	Z2357 thru Z2359		COIL ASSEMBLY Z2357 19B204784-G4 Z2358 19B204784-G5
				22359 19B204784-G6
	Contact, electrical; sim to Amp 42827-2.	25	E406030 PG:5	
	RESISTORS	C7 and C8	5496218-P248	Ceramic disc: 24 pf $\pm 5\%$, 500 VDCW, temp coef-80 PPM.
	Deposited carbon: 0.28 megohm ±1%, 1/2 w; sim to Texas Instrument Type CD1/2MR.	С9	5496218-P244	Ceramic disc: 15 pf ±5%, 500 VDCW, temp coef -80 PPM.
	Composition: 100 ohms ±10%, 1/4 w.			
			5491798-P1	Tuning slug. (Used in Z2357).
	Miniature, phen: 4 terminals.		5491798-P4	Tuning slug. (Used in Z2358).
			5491798-P5	Tuning slug. (Used in Z2359).
	CONNECTOR ASSEMBLY 19B204930-G1			PLATE ASSEMBLY - TRUNK MOUNT 19B205195-G2
	Ceramic disc: .001 µf ±10%, 500 VDCW.		19A121759-P1 4036436-P2	Thumbscrew: 1/4-20 thread. Nut, push-on; sim to Fastex 8063-21-00.
	JACKS AND RECEPTACLES		19B205194-P2	Plate.
	Receptacle, panel, coaxial: mica-filled insert, UHF contact. Signal Corps SO-239 or sim to Amphenl 83-1R.			PLATE ASSEMBLY - FRONT MOUNT 19B204446-G4
	MISCELLANEOUS			MISCELLANEOUS
	Cable, RF: 1200 VRMS max, approx 40 inches.		19A121759-P1	Thumbscrew: 1/4-20 thread.
	TUNED CIRCUITS		4036436-P2	Nut, push-on: sim to Fastex 8063-21-00.
	COIL ASSEMBLY		19B205638-P1	Plate.
	Z2351 19B204786-G1 Z2352 19B204786-G2 Z2353 19B204786-G3			ANTENNA LOADING COIL MODEL 4KY9A1
				INDUCTORS
	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef -80 PPM.		4039109-P1	Coil: operating freq 25-54 MHz; sim to Antenna Specialists ASPA87.
	Ceramic disc: 30 pf ±5%, 500 VDCW, temp coef -80 PPM.			MECHANICAL PARTS
	Ceramic disc: 18 pf ±5%, 500 VDCW, temp coef	1	19E500817-P2	(SEE RC-1235) Chassis. (Used in 19D402497-G1, 2).
	Ceramic disc: .002 µf ±10%, 1000 VDCW; sim to	2	19E500817-P1	Chassis. (Used in 19D402497-G1, 2). Chassis. (Used in 19D402497 G3-6).
	RMC Type JF Discap.	3	4029851-P3	Cable clamp: nylon; sim to Weckesser 1/8-4.
	INDUCTORS	4	19C303649-P1	Support. (Mounts cover).
	Coil. Tuning slug (Used in 72351)	5	19A121383-P1	Support.
	Tuning slug. (Used in Z2351). Tuning slug. (Used in Z2352).	"	19B204383-P1	Cover.
	Tuning slug. (Used in Z2353).		1	
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SYMBOL	G-E PART NO	DESCRIPTION
7	19C311172-P1	Crystal socket. (Part of XYl in A2353, 2354)
8	19Al15793-Pl	Electrical contact: sim to Methode 752 V (PB). (Part of XY1 in A2353, 2354).
9	19B200525-P9	Rivet. (Part of XY1 in A2353, 2354).
10	4033089-P1	Clip. (Part of XYl in A2353, 2354).
11	19A121435-P1	Support. (Used in A2355, 2356).
12	19B204672-P1	Cover.
13	7162414-P1	Mounting ring, transistor socket; sim to Elco 757. (Used with Ql in A2351).
14	19B204917-P1	Support. (Used with A2351).



ORDERING SERVICE PARTS

Each component appearing on the schematic diagram is identified by a symbol number, to simplify locating it in the parts list. Each component is listed by symbol number, followed by its description and GE Part Number.

Service parts may be obtained from Authorized GE Communication Equipment Service Stations or through any GE Radio Communication Equipment Sales Office. When ordering a part, be sure to give:

- GE Part Number for component
 Description of part
- 3. Model number of equipment
- 4. Revision letter stamped on unit

These instructions do not purport to cover all details or variations in equipment nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired, or should particular problems arise which are not covered sufficiently for the purchaser's purposes, contact the nearest Radio Communication Equipment Sales Office of the General Electric Company.

COMMUNICATION PRODUCTS DEPARTMENT LYNCHBURG. VIRGINIA

(In Canada, Canadian General Electric Company, Ltd., 100 Wingold Ave., Toronto 19, Ontario)